



# Product Change Notification

## 113306 - 00

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# Product Change Notification

**Change Notification #:** 113306 - 00  
**Change Title:** Intel® Server System R1304SP4SHOC  
PCN 113306-00, Product Design  
Add a Mylar and a Plastic Block  
**Date of Publication:** October 17, 2014

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

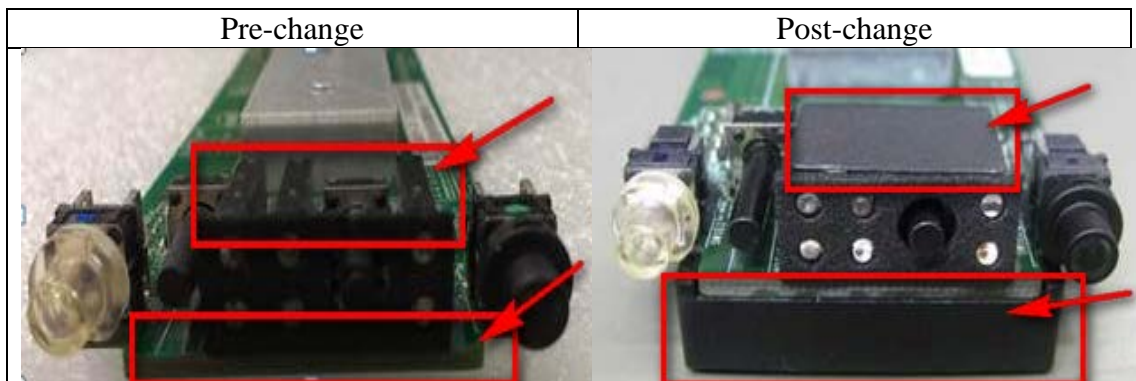
<b>Date Customer Must be Ready to Receive Post-Conversion Material *:</b>	November 1, 2014
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R1304SP4SHOC:

Add a mylar on the top of the front panel board and add a plastic block for the front end under the front panel board to hold parts more securely. See the images below:



## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes. Customers may need to validate the function and feature changes once the post-change system is available.

## Products Affected / Intel Ordering Codes:

CORE SKU			
Product Code	MM#	Pre Change TA	Post Change TA
R1304SP4SHOC	920598	G74428-002	G74428-003

## PCN Revision History:

**Date of Revision:**  
October 17, 2014

**Revision Number:**  
00

**Reason:**  
Originally Published PCN